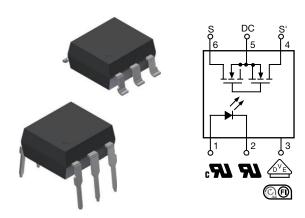


1 Form A Solid-State Relay



LINKS TO ADDITIONAL RESOURCES







DESCRIPTION

The VO14642 is a high speed single channel normally open solid-state relay (SPST - 1 form A) in a DIP-6 package. The relay is constructed as a multi-chip hybrid device. A high efficient infrared LED enables low forward current on the input side. On the output side high performance MOSFET switches provide a low $R_{\rm ON}$ and can be configured for AC/DC or DC only operation.

FEATURES

- High speed SSR t_{on}/t_{off} < 800 μs
- Maximum R_{ON} 0.25 Ω
- Isolation test voltage 5300 V_{RMS}
- Load voltage 60 V
- Load current 2 A_{DC} configuration
- DIP-6 package
- · Clean bounce free switching
- TTL / CMOS compatible input
- Available on tape and reel
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

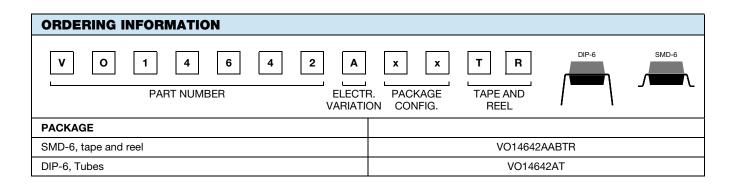
- Instrumentation
- Industrial controls
- Security
- Automatic measurement equipment

AGENCY APPROVALS

- UL 1577
- cUL
- DIN EN 60747-5-5 (VDE 0884-5)
- FIMKO

Note

 Agency approvals are valid only for ambient temperature range -40 °C to 85 °C





ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
INPUT	<u> </u>				
LED continous forward current		I _F	50	mA	
LED reverse voltage		V_{R}	5	V	
LED power dissipation	At 25 °C	P _{diss}	80	mW	
OUTPUT	<u> </u>				
DC or peak AC load voltage		V_{L}	60	V	
Load current (DC only)		ΙL	2000	mA	
Peak load current (AC/DC)	t = 10 ms	I _{LPK}	3.6	Α	
Output power dissipation	At 25 °C	P _{diss}	250	mW	
SSR					
Total power dissipation		P _{diss}	330	mW	
Ambient temperature range		T _{amb}	-55 to +85	°C	
Storage temperature range		T _{stg}	-55 to +125	°C	
Soldering temperature (1)	t ≤ 10 s max.	T _{sld}	260	°C	

Notes

ABSOLUTE MAXIMUM RATING CURVE

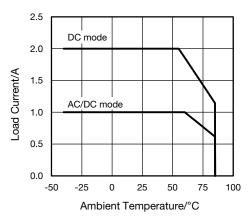


Fig. 1 - Load Current (AC/DC) vs. Temperature

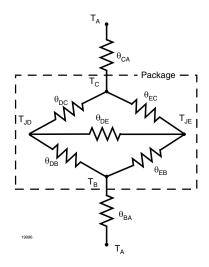
THERMAL CHARACTERISTICS					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Maximum LED junction temperature	At 25 °C	T _{jmax.}	125	°C	
Maximum output die junction temperature	At 25 °C	T _{jmax.}	125	°C	
Thermal resistance, junction emitter to board	At 25 °C	θ_{EB}	176	°C/W	
Thermal resistance, junction emitter to case	At 25 °C	$\theta_{\sf EC}$	208	°C/W	
Thermal resistance, junction detector to board	At 25 °C	θ_{DB}	67	°C/W	
Thermal resistance, junction detector to case	At 25 °C	θ_{DC}	134	°C/W	
Thermal resistance, junction emitter to junction detector	At 25 °C	θ_{ED}	310	°C/W	
Thermal resistance, case to ambient	At 25 °C	θ_{CA}	2180	°C/W	

Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.

⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

The thermal model is represented in the thermal network below. Each resistance value given in this model can be used to calculate the
temperatures at each node for a given operating condition. The thermal resistance from board to ambient will be dependent on the type of
PCB, layout and thickness of copper traces. For a detailed explanation of the thermal model, please reference Vishay's thermal
characteristics of optocouplers application note.

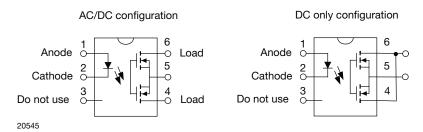


ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT	INPUT					
LED forward current, switch turn-on	$I_L = 1 \text{ A}, V_L \le 0.5 \text{ V}, t = 10 \text{ ms}$	I _{Fon}	-	0.5	2	mA
LED forward current, switch turn-off	$V_L = 60 \text{ V}, I_L < 1 \mu\text{A}$	I _{Foff}	50	-	-	μA
LED reverse current	V _R = 5 V	I _R	-	-	10	μA
LED forward voltage	I _F = 10 mA	V _F	1	1.3	1.5	V
OUTPUT						
On-resistance (AC/DC)	I _F = 10 mA, I _L = 1 A	R _{ON}	-	0.18	0.25	Ω
On-resistance (DC only)	I _F = 10 mA, I _L = 2 A	R _{ON}	-	0.05	0.07	Ω
Off-state leakage current	$I_F = 0 \text{ mA}, V_L = 60 \text{ V}$	I _{LEAK}	-	-	1	μΑ

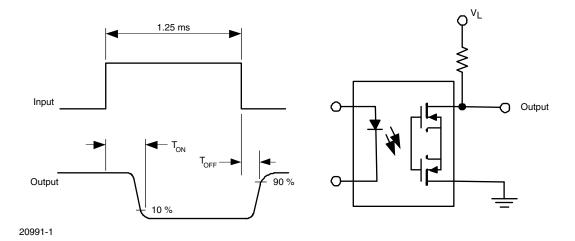
Note

• Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

PIN CONFIGURATION



SWITCHING CHARACTERISTICS (AC/DC CONNECTION)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	I _F = 10 mA, V _L = 30 V, I _L = 200 mA	t _{on}	-	370	800	μs
Turn-off time	$I_F = 10 \text{ mA}, V_L = 30 \text{ V}, I_L = 200 \text{ mA}$	t _{off}	-	50	800	μs
Turn-on time	$I_F = 10 \text{ mA}, V_L = 5 \text{ V}, I_L = 1 \text{ A}$	t _{on}	-	550	-	μs
Turn-off time	I _F = 10 mA, V _L = 5 V, I _L = 1 A	t _{off}	-	18	-	μs



PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 085 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group Illa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, t = 1 min	V _{ISO}	5300	V_{RMS}
Maximum transient isolation voltage	According to DIN EN 60747-5-5	V _{IOTM}	8000	V _{peak}
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	V _{IORM}	890	V _{peak}
	T _{amb} = 25 °C, V _{IO} = 500 V	R _{IO}	≥ 10 ¹²	Ω
Isolation resistance	T _{amb} = 100 °C, V _{IO} = 500 V	R _{IO}	≥ 10 ¹¹	Ω
	$T_{amb} = T_S$, $V_{IO} = 500 \text{ V}$	R _{IO}	≥ 10 ⁹	Ω
Output safety power		P _{SO}	400	mW
Input safety current		I _{SI}	150	mA
Input safety temperature		T _S	165	°C
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Insulation thickness		DTI	≥ 0.4	mm

Note

This SSR is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by
means of protective circuits.

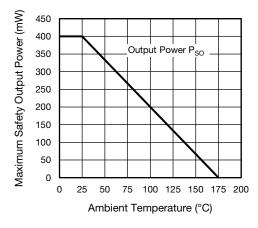


Fig. 2 - Safety Derating (input)

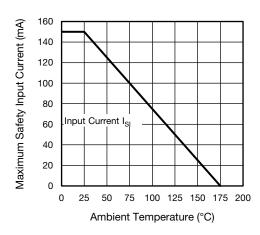


Fig. 3 - Safety Derating (output)

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

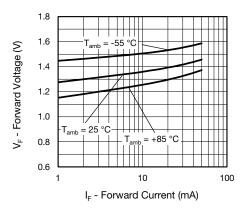


Fig. 4 - Forward Voltage vs. Forward Current

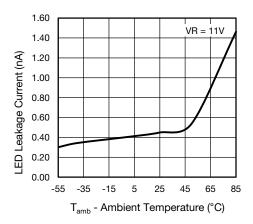


Fig. 5 - LED Leakage Current vs. Ambient Temperature

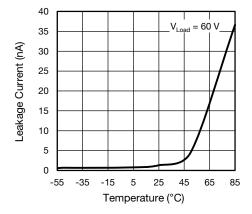


Fig. 6 - Leakage Current vs. Temperature

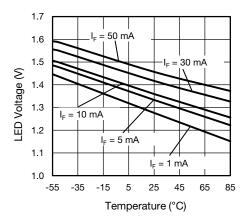


Fig. 7 - LED Voltage vs. Temperature

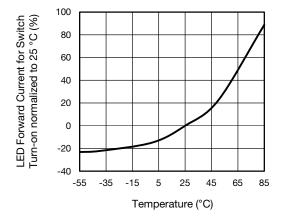


Fig. 8 - LED Forward Current for Switch Turn-On vs. Temperature

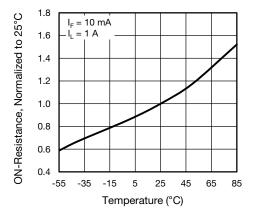


Fig. 9 - On-Resistance vs. Temperature



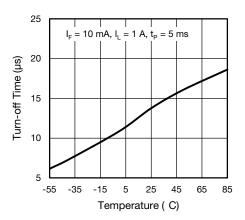


Fig. 10 - Turn-Off Time vs. Temperature

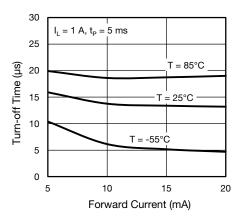


Fig. 11 - Turn-Off Time vs. Forward Current

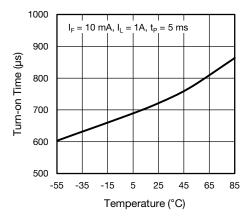


Fig. 12 - Turn-On Time vs. Temperature

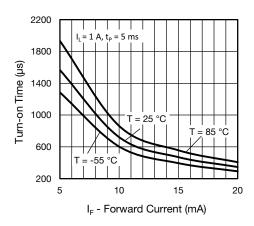


Fig. 13 - Turn-On Time vs. Forward Current

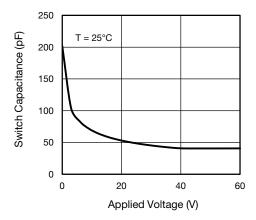


Fig. 14 - Switch Capacitance vs. Applied Voltage

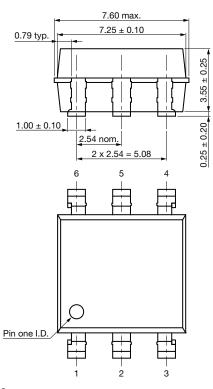
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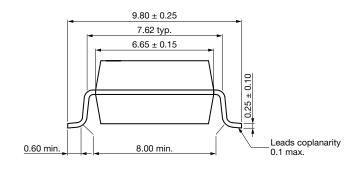




PACKAGE DIMENSIONS (in millimeters)

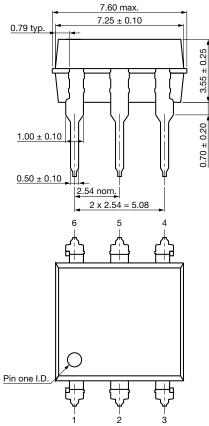
SMD-6

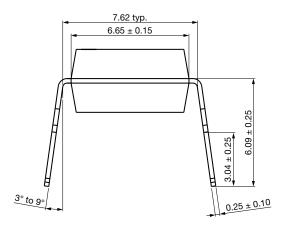




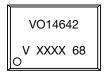
Recommended footprint 8.0 min. 11.00

DIP-6





PACKAGE MARKING



Notes

- XXXX = LMC (lot marking code)
- Tape and reel suffix "TR" is not part of the package marking

PACKING INFORMATION (in millimeters)

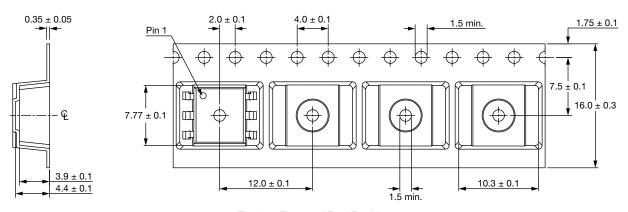


Fig. 15 - Tape and Reel Packing

TAPE AND REEL PACKING		
TYPE	UNITS/REEL	
SMD-6	1000	

TUBE PACKING				
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX	
DIP-6	50	40	2000	

SOLDER PROFILES

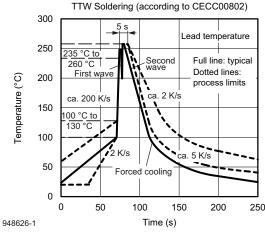


Fig. 16 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices

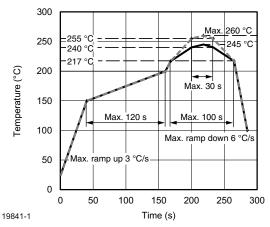


Fig. 17 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices



VO14642AT, VO14642AABTR

Vishay Semiconductors

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions: $T_{amb} <$ 30 °C, RH < 85 % Moisture sensitivity level 1, according to J-STD-020





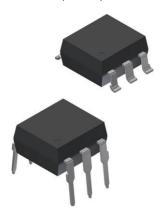
Footprint and Schematic Information for VO14642AAB, VO14642AT

The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

PART NUMBER	FOOTPRINT / SCHEMATIC		
VO14642AAB	www.snapeda.com/parts/VO14642AAB/Vishay/view-part		
VO14642AT	www.snapeda.com/parts/VO14642AT/Vishay/view-part		

For technical issues and product support, please contact optocoupleranswers@vishav.com.





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